

| VDS | RDS(on) | ID@25℃ |
|------|---------|--------|
| 650V | 30mΩ | 55A |

Applications:

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- EV Charging
- Motor Drives

Features:

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness

Benefits:

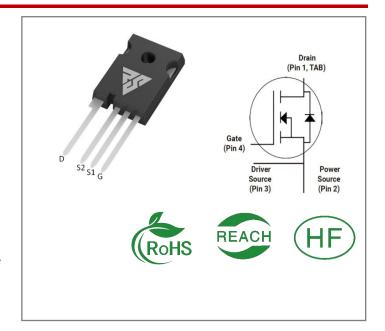
- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Ordering Information

| Part Number | Package | Marking | Packing | Qty. |
|-------------|----------|------------|---------|--------|
| RSM065030Z | TO-247-4 | RSM065030Z | Tube | 30 PCS |

Maximum Ratings (TJ= 25℃ unless otherwise specified)

| Symbol | Parameter | Value | Unit | Test Conditions | Note |
|-----------|---|-----------------|------------------------|---|------|
| VDSmax | Drain - Source Voltage | 650 | ٧ | VGS=0V,ID =100μA | |
| VGSmax | Gate - Source Voltage | -8/+22 V | | Absolute maximum values | |
| VGSop | Gate - Source Voltage | -5/+18 | ٧ | Recommended operational values | |
| ID | Continuous Drain Current | 55 39 | А | VGS=18V, TC =25°C VGS=18V, TC =100°C | |
| ID(pulse) | Pulsed Drain Current | 197 A | | Pulse width tp limited by TJmax | |
| PD | Power Dissipation | 187 | W | TC =25℃, TJ =175℃ | |
| TL | Solder Temperature | 260 | $^{\circ}\!\mathbb{C}$ | | |
| TJ, Tstg | Operating Junction and StorageTemperature | -40 to + 175 | ${\mathbb C}$ | | |





Electrical Characteristics (TJ= 25 °C unless otherwise specified)

| Symbol | Parameter | Min. | Тур. | Max. | Unit | Test Conditions | Note |
|--------------|------------------------------------|------|----------|------|------|---|------|
| V(BR)D SS | Drain-Source Breakdown Voltage | 650 | | | ٧ | VGS=0V,ID =100μA | |
| \/C\$(+b) | Gate Threshold | 1.8 | 2.6 | 4.0 | V | VGS= VDS, IDS=5mA,TC =25℃ | |
| VGS(th) | Voltage | | 1.8 | | V | VGS= VDS, IDS=5mA,TC =175℃ | |
| IDSS | Zero Gate Voltage Drain Current | | 1 | 50 | μΑ | VDS= 650V, VGS=0V | |
| IGSS | Gate-Source Leakage Current | | 10 | 250 | nA | VGS=22V, VDS= 0V | |
| RDS(on) | Drain-Source on-state | | 30 | 50 | mΩ | VGS=18V, ID =25A, TC =25℃ | |
| KD3(0II) | Resistance | | 42 | | | VGS=18V, ID =25A, TC =175℃ | |
| Ciss | Input Capacitance | | 185 0 | | | VGS=0V, VDS=400 V, | |
| Coss | Output Capacitance | | 160 | | pF | f=1MHz, VAC=25 mV | |
| Crss | Reverse Transfer Capacitance | | 15 | | | , | |
| EON | Turn-On Switching Energy | | 50 | | μЈ | VDS =400V, VGS =-5/18V,ID = 25A, | |
| EOFF | Turn-Off Energy | | 65 | | μ | RG(ext) = 2.5Ω, L= 100μH | |
| td(on) | Turn-On Delay Time | | 14 | | | | |
| tr | Rise Time | | 15 | | ns | VDS =400V, VGS =-5/18 V ID = 25A, RG(ext) =2. 5 Ω, | |
| td(off) | Turn-Off Delay Time | | 28 | | 113 | $RL = 16\Omega$ | |
| tf | Fall Time | | 8 | | | | |
| RG(int) | Internal Gate Resistance | | 3 | | Ω | f=1 MHz, VAC=25mV | |
| Qgs | Gate to Source Charge | | 30 | | nC | | |
| Qgd | Gate to Drain Charge | | 32 | | nC | VDS=400V, VGS=-5/18V ID = 5A | |
| Qg | Total Gate Charge | | 110 | | | | |



Reverse Diode Characteristics (TJ= 25°C unless otherwise specified)

| Symbol | Parameter | Тур. | Max | Unit | Test Conditions | Note |
|--------|----------------------------------|-------|-----|------|----------------------------------|------|
| VCD | Diada Famuard Valtara | 4.2 | | V | VGS=-5V, ISD = 12.5 A, TJ = 25℃ | |
| VSD | Diode Forward Voltage | 3.8 V | | V | VGS=-5V, ISD=12.5 A, TJ= 175℃ | |
| IS | Continuous Diode Forward Current | | 45 | Α | VGS=-5V,TC= 25°C | |
| trr | Reverse Recovery time | 25 | | ns | | |
| Qrr | Reverse Recovery Charge | 100 | | nC | ISD= 25 A, VR = 400V | |
| Irrm | Peak Reverse Recovery Current | 5 | | Α | | |

Thermal Characteristics (TJ= 25°C unless otherwise specified)

| Symbol | Symbol Parameter | | Unit | Test Conditions | Not e | |
|--------|---|-----|------|-----------------|----------|--|
| RθJC | Thermal Resistance from Junction to Case | 0.8 | °C/W | | | |
| RθJA | Thermal Resistance From Junction to Ambient | 40 | C/VV | | | |

Typical Feature Curve

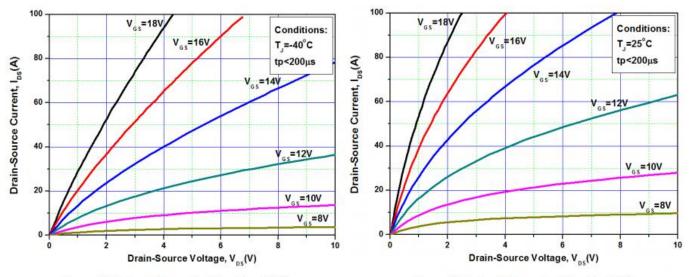
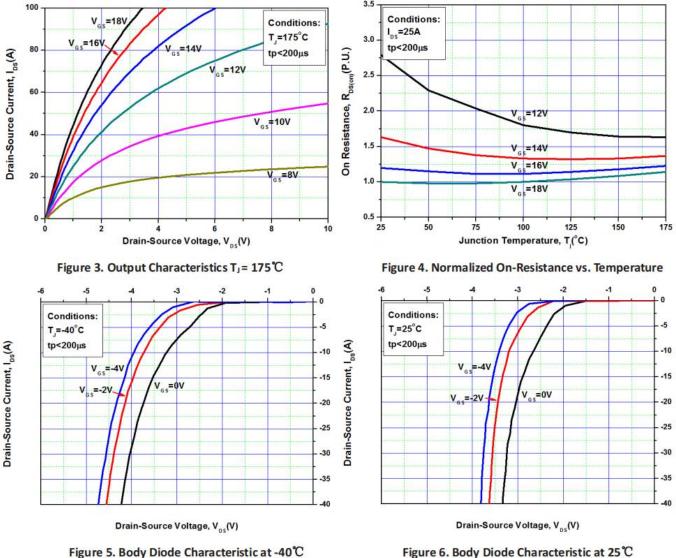


Figure 1. Output Characteristics T₁ = -40°C

Figure 2. Output Characteristics T₁ = 25°C





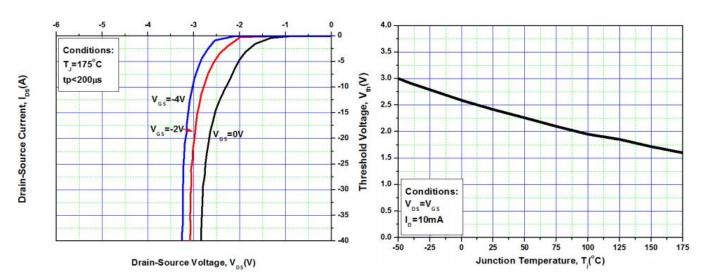


Figure 7. Body Diode Characteristic at 175℃

Figure 8. Threshold Voltage vs. Temperature



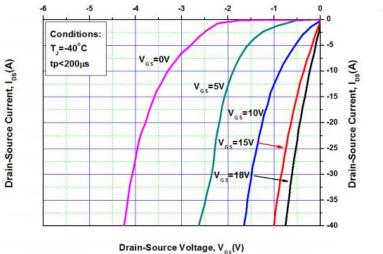


Figure 9. 3rd Quadrant Characteristic at -40 °C

Figure 10. 3rd Quadrant Characteristic at 25°C

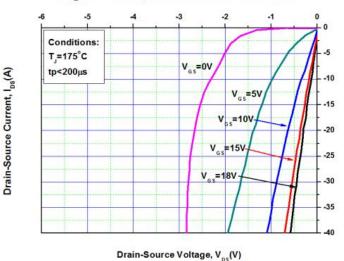
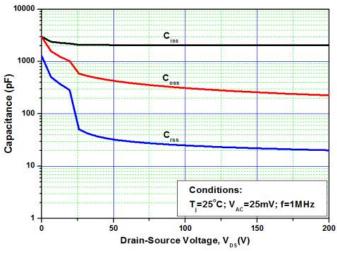


Figure 11. 3rd Quadrant Characteristic at 175℃



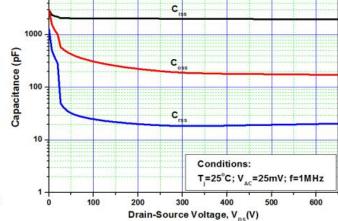


Figure 12. Capacitances vs. Drain-Source Voltage (0 - 200V)

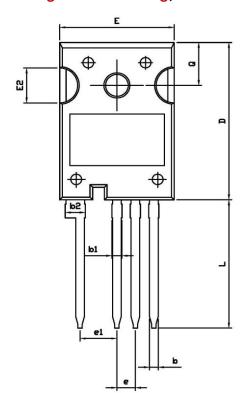
Figure 13. Capacitances vs. Drain-Source Voltage (0 - 650V)

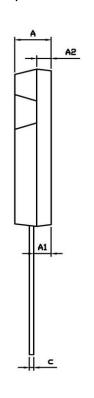
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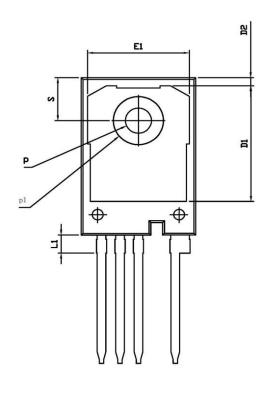
10000



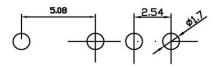
Package outline drawing(TO-247-4 Unit: mm)







RECOMMENDED LAND PATTERN



UNIT: mm

| | 48 | | |
|----|-------|--------|--------|
| | MIN | NOM | MAX |
| A | 4.80 | 5.00 | 5. 20 |
| A1 | 2. 25 | 2.40 | 2.45 |
| A2 | 1.85 | 2.00 | 2. 15 |
| b | 1.05 | 1.20 | 1.35 |
| b1 | 1.00 | 1.30 | 1.60 |
| b2 | 2.35 | 2.65 | 2.95 |
| С | 0.50 | 0.60 | 0.70 |
| D | 22.34 | 22.54 | 22.74 |
| D1 | 16.00 | 16. 50 | 17.00 |
| D2 | 0.97 | 1.17 | 1. 37 |
| е | 2. 34 | 2.54 | 2.74 |
| e1 | 4.88 | 5. 08 | 5. 28 |
| Е | 15.60 | 15.80 | 16.00 |
| E1 | 13.50 | 14.00 | 14. 50 |
| E2 | 4.80 | 5.00 | 5. 20 |
| L | 18.08 | 18.38 | 18. 68 |
| L1 | 2.38 | 2.58 | 2.78 |
| р | 3. 50 | 3.60 | 3. 70 |
| p1 | 6.60 | 6.80 | 7.00 |
| Q | 6.00 | 6. 15 | 6. 30 |
| S | 6.00 | 6. 15 | 6. 30 |



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